

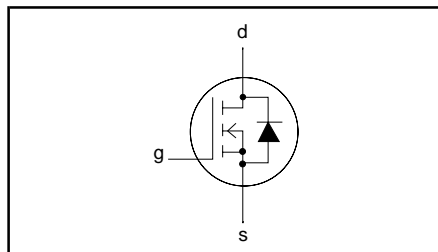
**N-channel TrenchMOS™ transistor**

**PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T**

**FEATURES**

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

**SYMBOL**



**QUICK REFERENCE DATA**

$V_{DSS} = 150\text{ V}$
$I_D = 12.5\text{ A}$
$R_{DS(ON)} \leq 200\text{ m}\Omega$

**GENERAL DESCRIPTION**

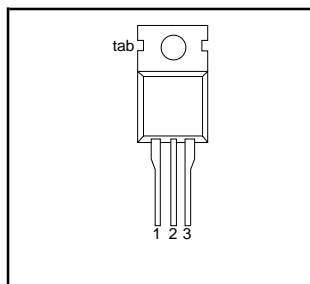
N-channel enhancement mode field-effect power transistor in a plastic envelope using 'trench' technology. The device has very low on-state resistance. It is intended for use in dc to dc converters and general purpose switching applications.

The PHP12NQ15T is supplied in the SOT78 (TO220AB) conventional leaded package.  
 The PHB12NQ15T is supplied in the SOT404 (D<sup>2</sup>PAK) surface mounting package.  
 The PHD12NQ15T is supplied in the SOT428 (DPAK) surface mounting package.

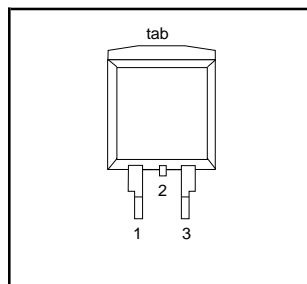
**PINNING**

PIN	DESCRIPTION
1	gate
2	drain <sup>1</sup>
3	source
tab	drain

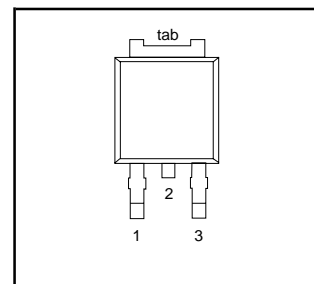
**SOT78 (TO220AB)**



**SOT404 (D<sup>2</sup>PAK)**



**SOT428 (DPAK)**



**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DSS}$	Drain-source voltage	$T_j = 25\text{ }^\circ\text{C to }175\text{ }^\circ\text{C}$	-	150	V
$V_{DGR}$	Drain-gate voltage	$T_j = 25\text{ }^\circ\text{C to }175\text{ }^\circ\text{C}; R_{GS} = 20\text{ k}\Omega$	-	150	V
$V_{GS}$	Gate-source voltage		-	$\pm 20$	V
$I_D$	Continuous drain current	$T_{mb} = 25\text{ }^\circ\text{C}; V_{GS} = 10\text{ V}$ $T_{mb} = 100\text{ }^\circ\text{C}; V_{GS} = 10\text{ V}$	-	12.5	A
$I_{DM}$	Pulsed drain current	$T_{mb} = 25\text{ }^\circ\text{C}$	-	50	A
$P_D$	Total power dissipation	$T_{mb} = 25\text{ }^\circ\text{C}$	-	88	W
$T_j, T_{stg}$	Operating junction and storage temperature		-55	175	$^\circ\text{C}$

<sup>1</sup> It is not possible to make connection to pin:2 of the SOT404 or SOT428 packages.

## N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T**AVALANCHE ENERGY LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$E_{AS}$	Non-repetitive avalanche energy	Unclamped inductive load, $I_{AS} = 9.5$ A; $t_p = 100$ $\mu$ s; $T_j$ prior to avalanche = $25^\circ$ C; $V_{DD} \leq 25$ V; $R_{GS} = 50$ $\Omega$ ; $V_{GS} = 10$ V; refer to fig:15	-	93	mJ
$I_{AS}$	Peak non-repetitive avalanche current		-	12.5	A

**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base	SOT78 package, in free air SOT404 & SOT428 packages, pcb mounted, minimum footprint	-	-	1.7	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient		-	60	-	K/W
			-	50	-	K/W

**ELECTRICAL CHARACTERISTICS** $T_j = 25^\circ$  C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0$ V; $I_D = 0.25$ mA; $T_j = -55^\circ$ C	150 133	-	-	V V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = 1$ mA $T_j = 175^\circ$ C $T_j = -55^\circ$ C	2 1 -	3 -	4 -	V V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10$ V; $I_D = 6$ A $T_j = 175^\circ$ C	-	180	200	m $\Omega$ m $\Omega$
$I_{GSS}$	Gate source leakage current	$V_{GS} = \pm 10$ V; $V_{DS} = 0$ V	-	10	100	nA
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 150$ V; $V_{GS} = 0$ V $T_j = 175^\circ$ C	-	0.05	10	$\mu$ A $\mu$ A
$Q_{g(tot)}$	Total gate charge	$I_D = 12$ A; $V_{DD} = 120$ V; $V_{GS} = 10$ V	-	20	-	nC
$Q_{gs}$	Gate-source charge		-	4.4	-	nC
$Q_{gd}$	Gate-drain (Miller) charge		-	8	-	nC
$t_{don}$	Turn-on delay time	$V_{DD} = 75$ V; $R_D = 6.8$ $\Omega$ ; $V_{GS} = 10$ V; $R_G = 5.6$ $\Omega$ Resistive load	-	8	-	ns
$t_r$	Turn-on rise time		-	20	-	ns
$t_{doff}$	Turn-off delay time		-	20	-	ns
$t_f$	Turn-off fall time		-	12	-	ns
$L_d$	Internal drain inductance	Measured tab to centre of die	-	3.5	-	nH
$L_d$	Internal drain inductance	Measured from drain lead to centre of die (SOT78 package only)	-	4.5	-	nH
$L_s$	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
$C_{iss}$	Input capacitance	$V_{GS} = 0$ V; $V_{DS} = 25$ V; $f = 1$ MHz	-	860	-	pF
$C_{oss}$	Output capacitance		-	108	-	pF
$C_{rss}$	Feedback capacitance		-	57	-	pF

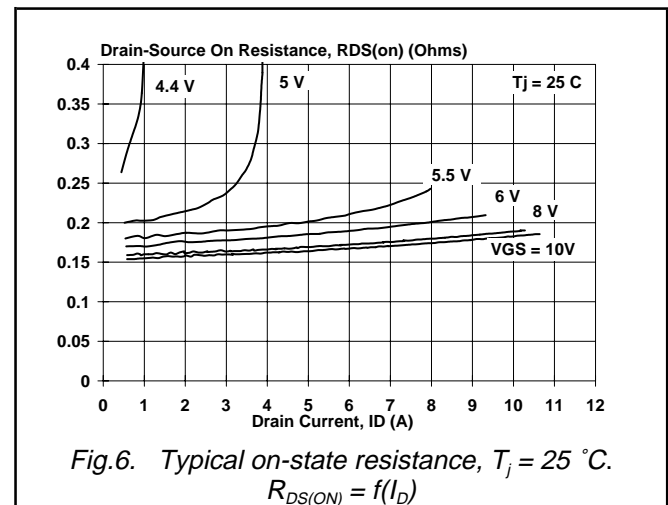
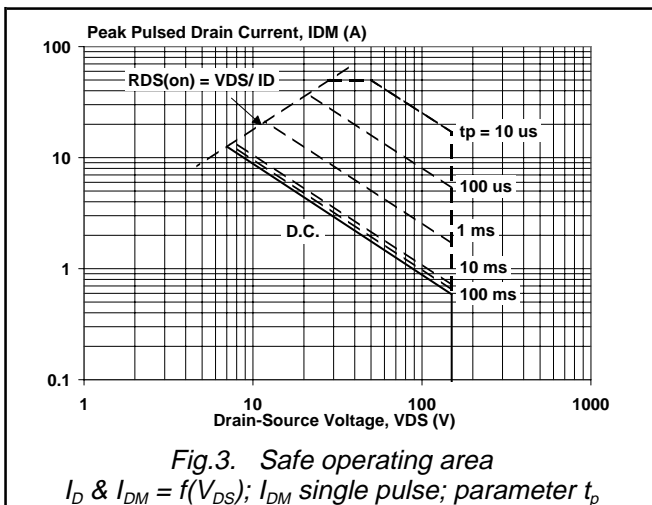
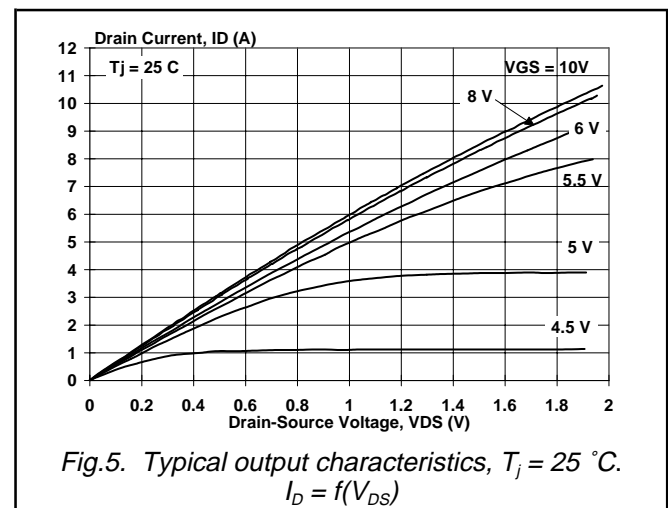
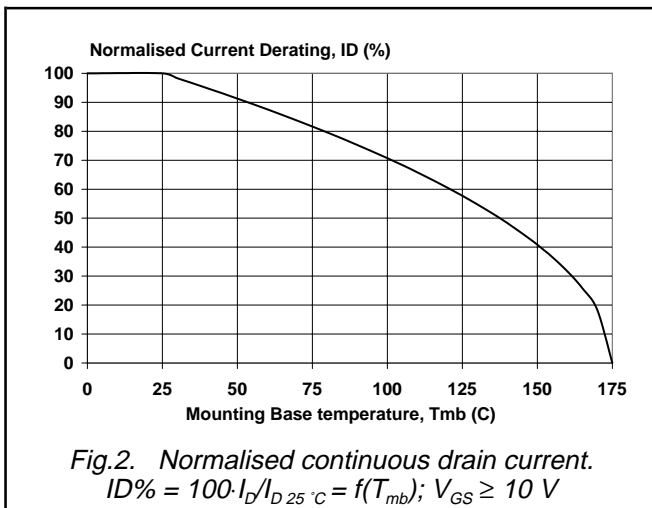
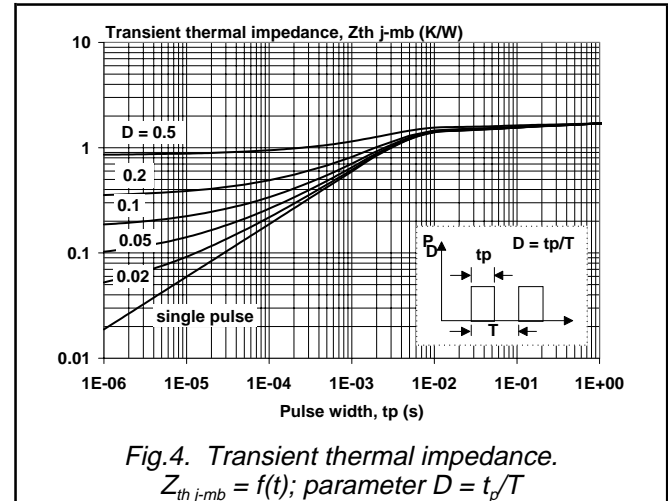
N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_S$	Continuous source current (body diode)		-	-	12.5	A
$I_{SM}$	Pulsed source current (body diode)		-	-	50	A
$V_{SD}$	Diode forward voltage	$I_F = 12\text{ A}; V_{GS} = 0\text{ V}$	-	0.86	1.2	V
$t_{rr}$	Reverse recovery time	$I_F = 12\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$ $V_{GS} = 0\text{ V}; V_R = 25\text{ V}$	-	95	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.56	-	$\mu\text{C}$

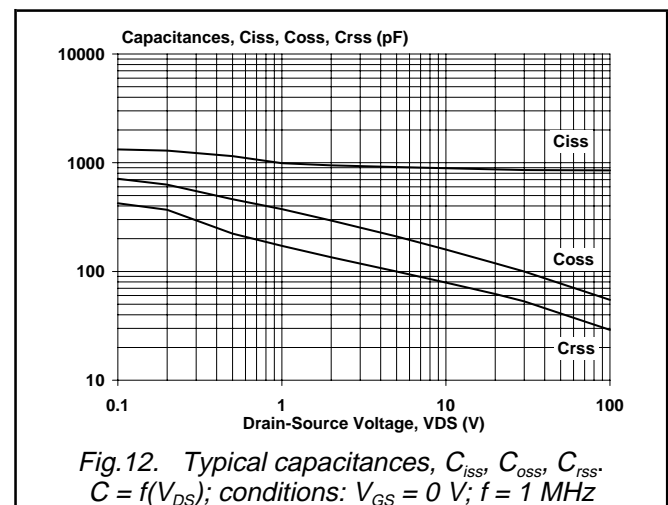
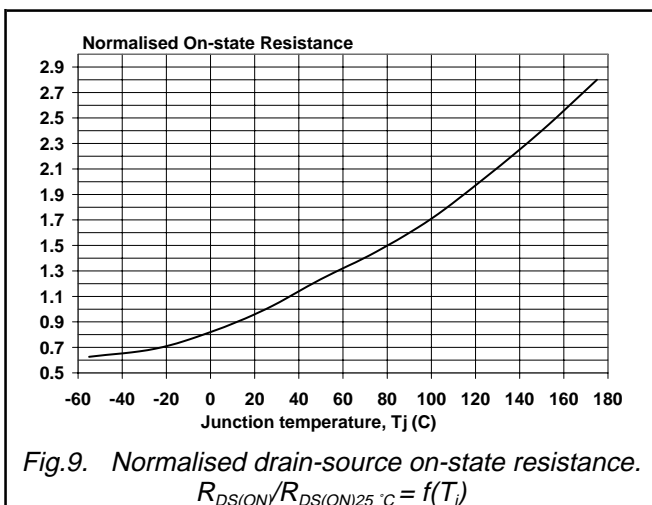
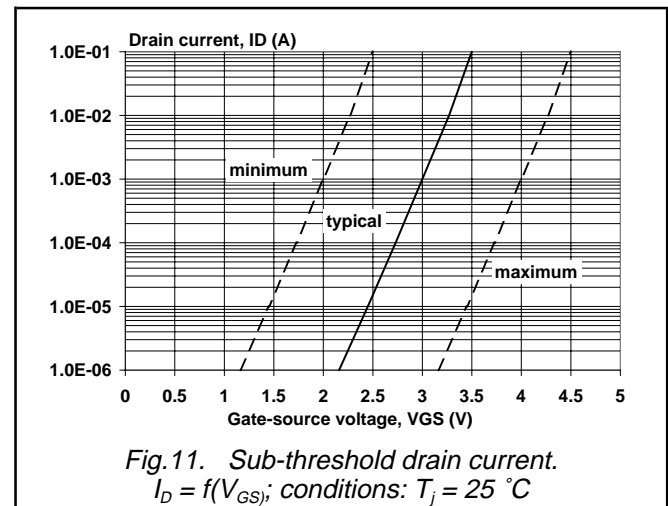
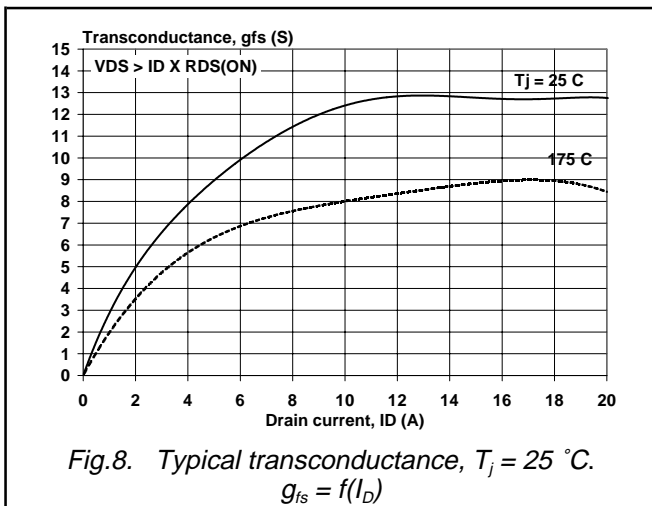
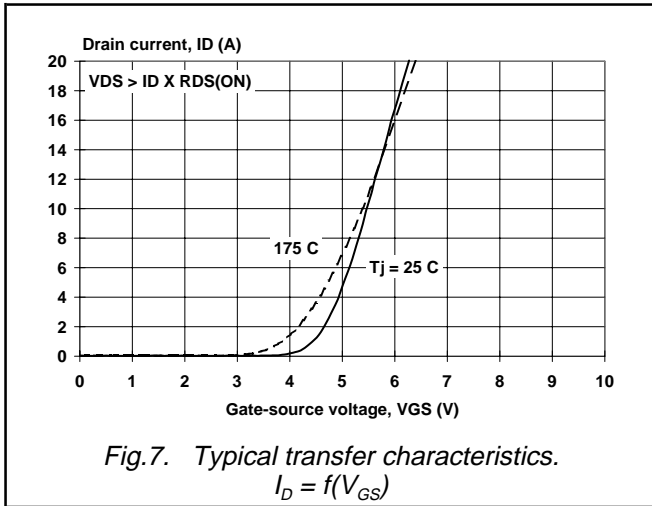
N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T



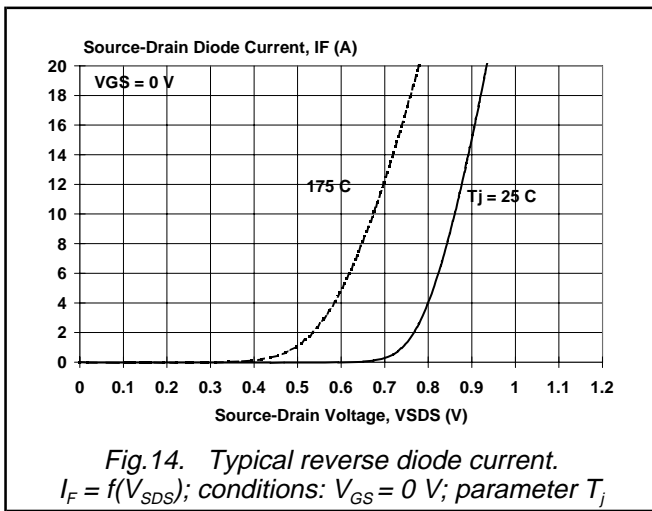
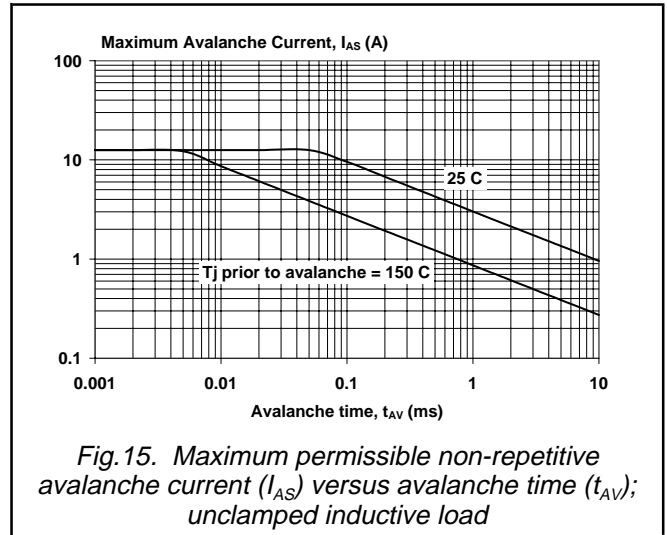
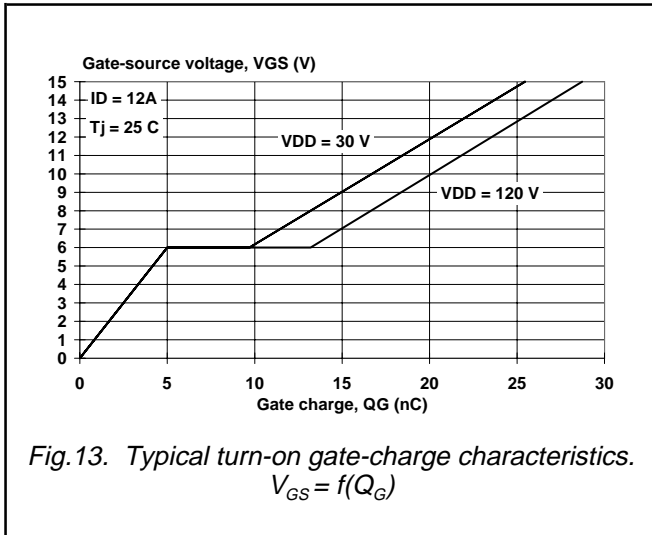
N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T



N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T



N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T

MECHANICAL DATA

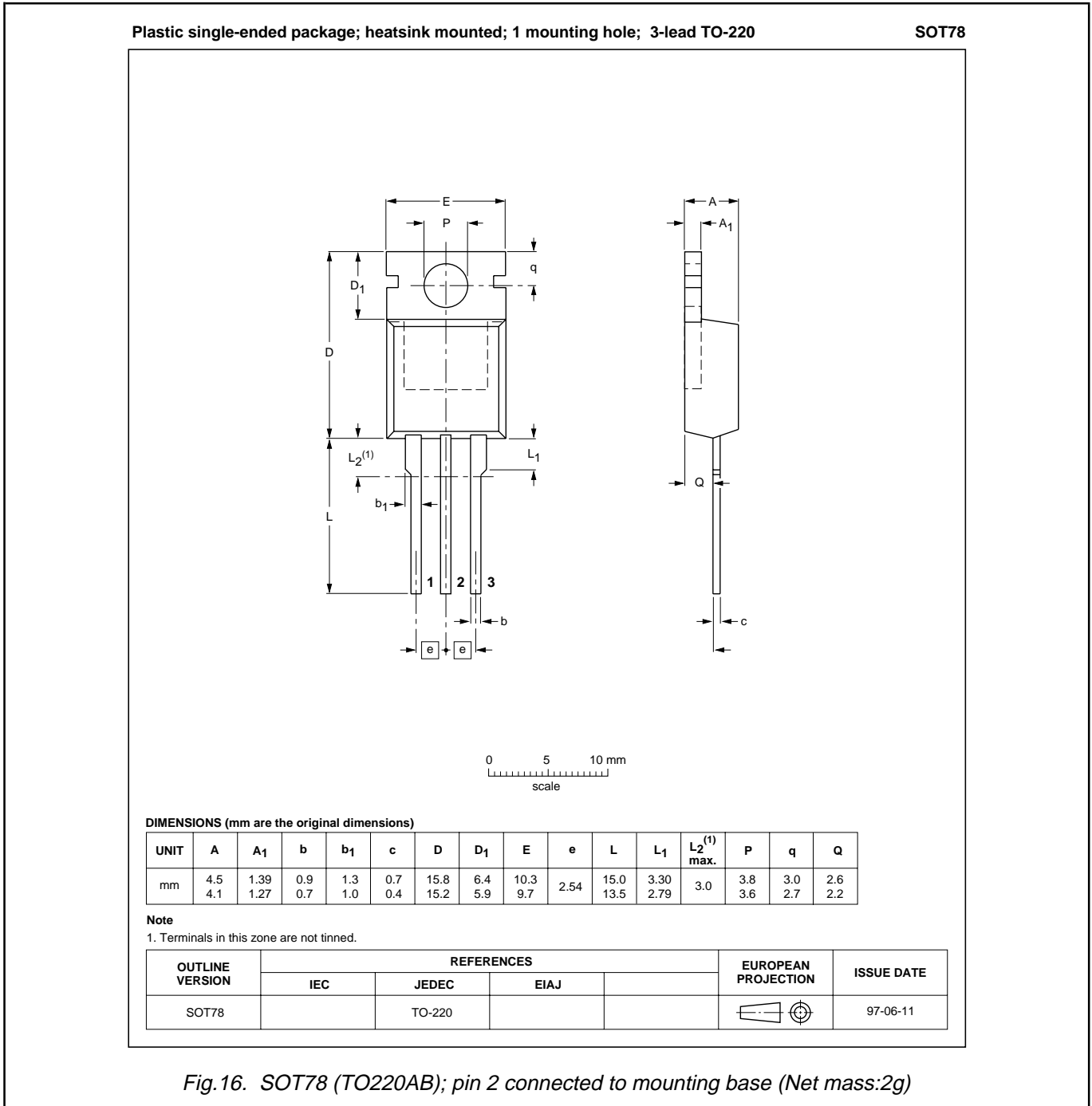


Fig. 16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".

N-channel TrenchMOS™ transistor

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MECHANICAL DATA

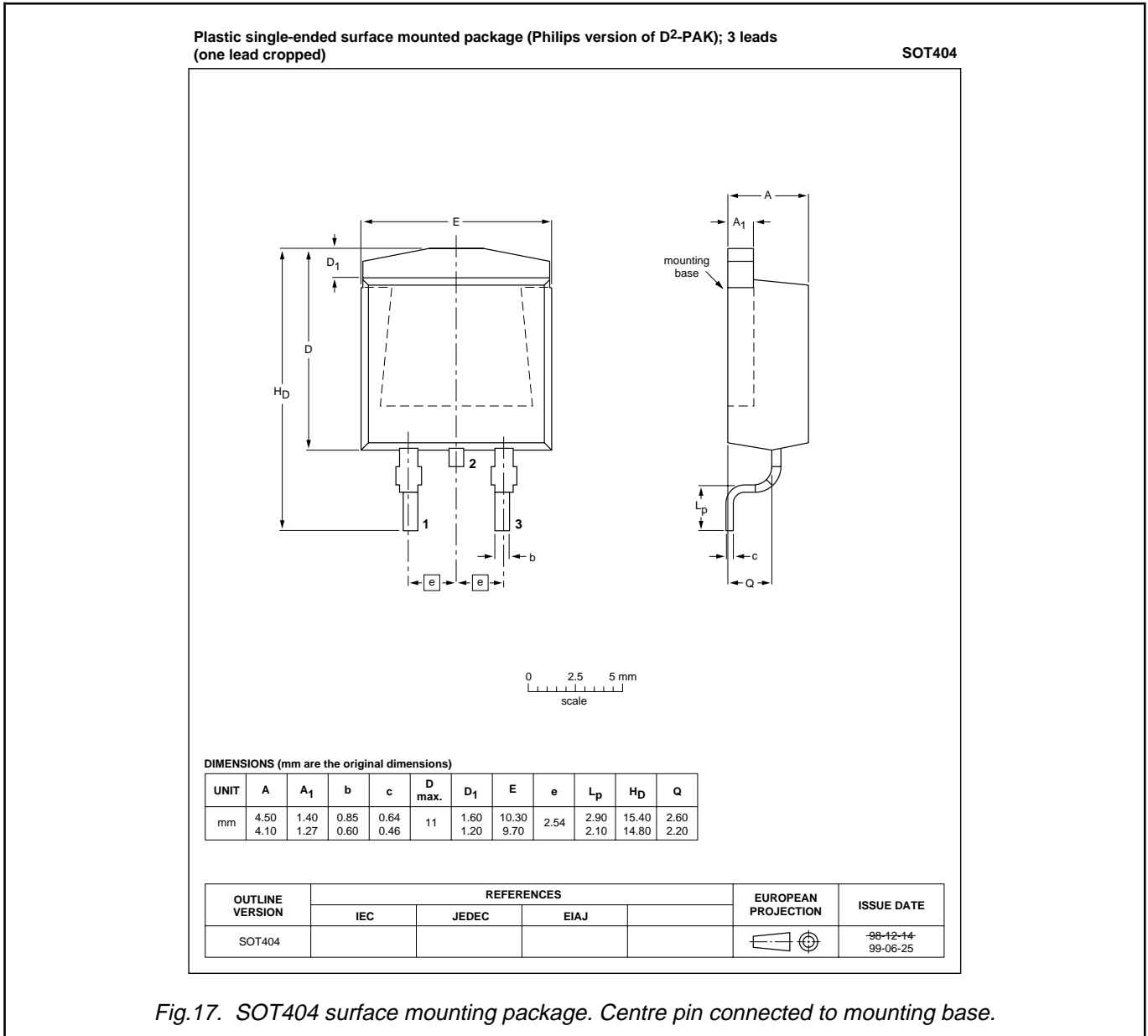


Fig.17. SOT404 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

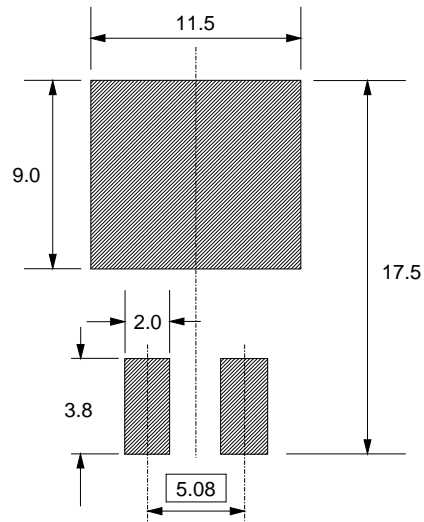


N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T

**MOUNTING INSTRUCTIONS**

*Dimensions in mm*



*Fig.18. SOT404 : soldering pattern for surface mounting.*

N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T

MECHANICAL DATA

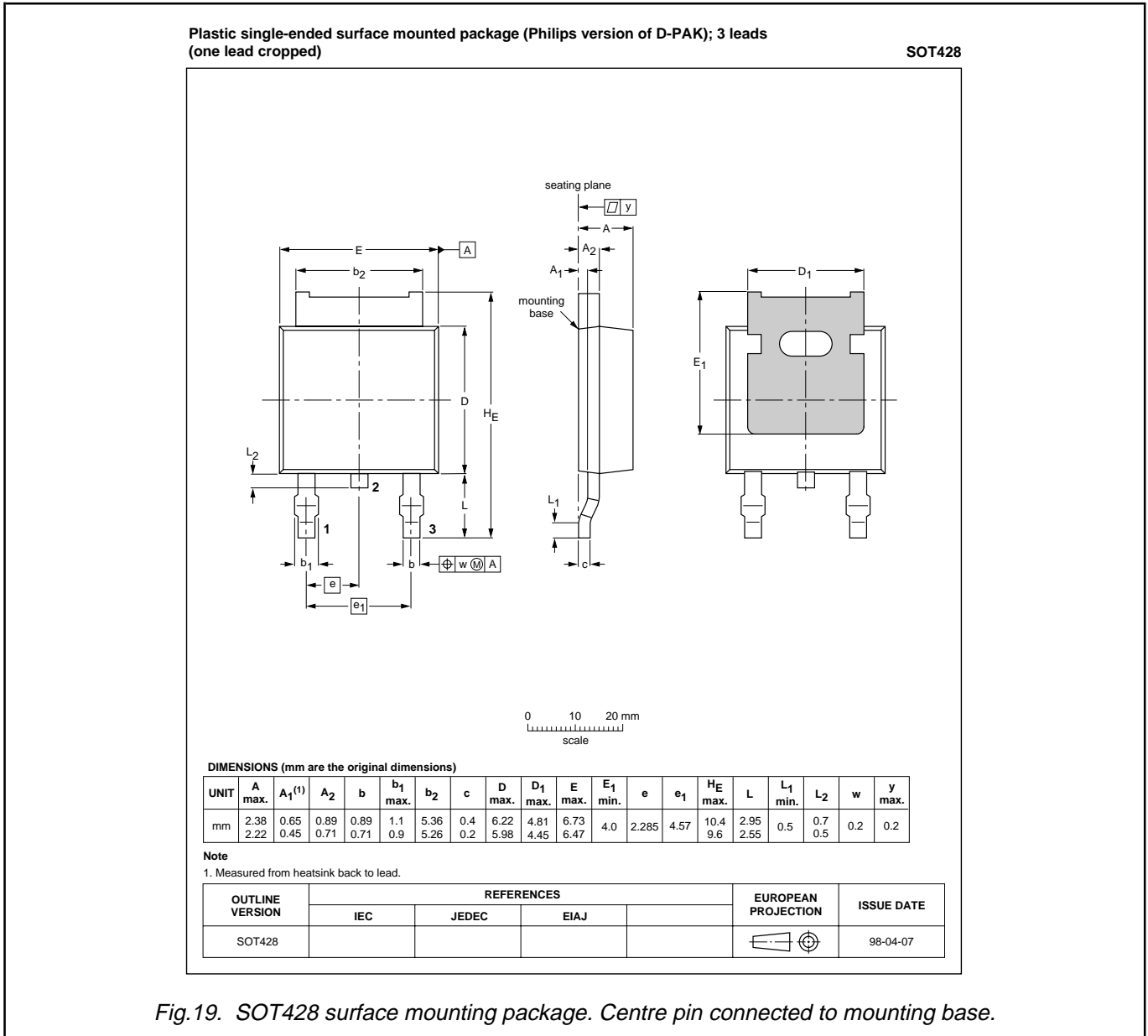


Fig.19. SOT428 surface mounting package. Centre pin connected to mounting base.

Notes

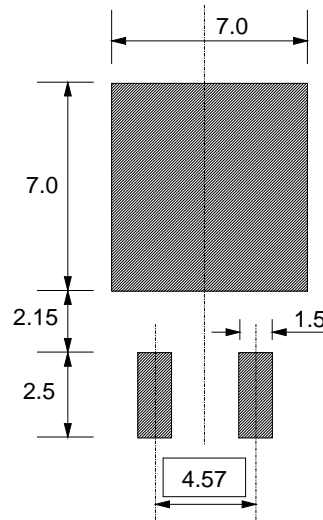
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3. Epoxy meets UL94 V0 at 1/8".

N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T

**MOUNTING INSTRUCTIONS**

*Dimensions in mm*



*Fig.20. SOT428 : soldering pattern for surface mounting.*

N-channel TrenchMOS™ transistor

PHP12NQ15T, PHB12NQ15T  
PHD12NQ15T**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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